

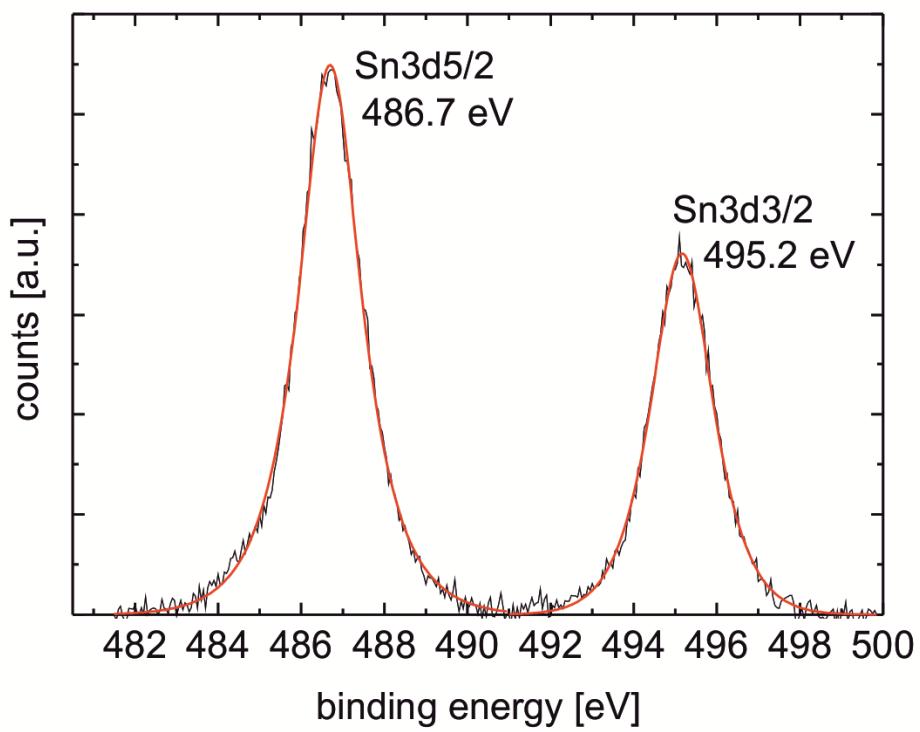
## Supplementary Information

### Room-temperature solution processed SnO<sub>x</sub> as electron extraction layer for inverted organic solar cells with superior thermal stability

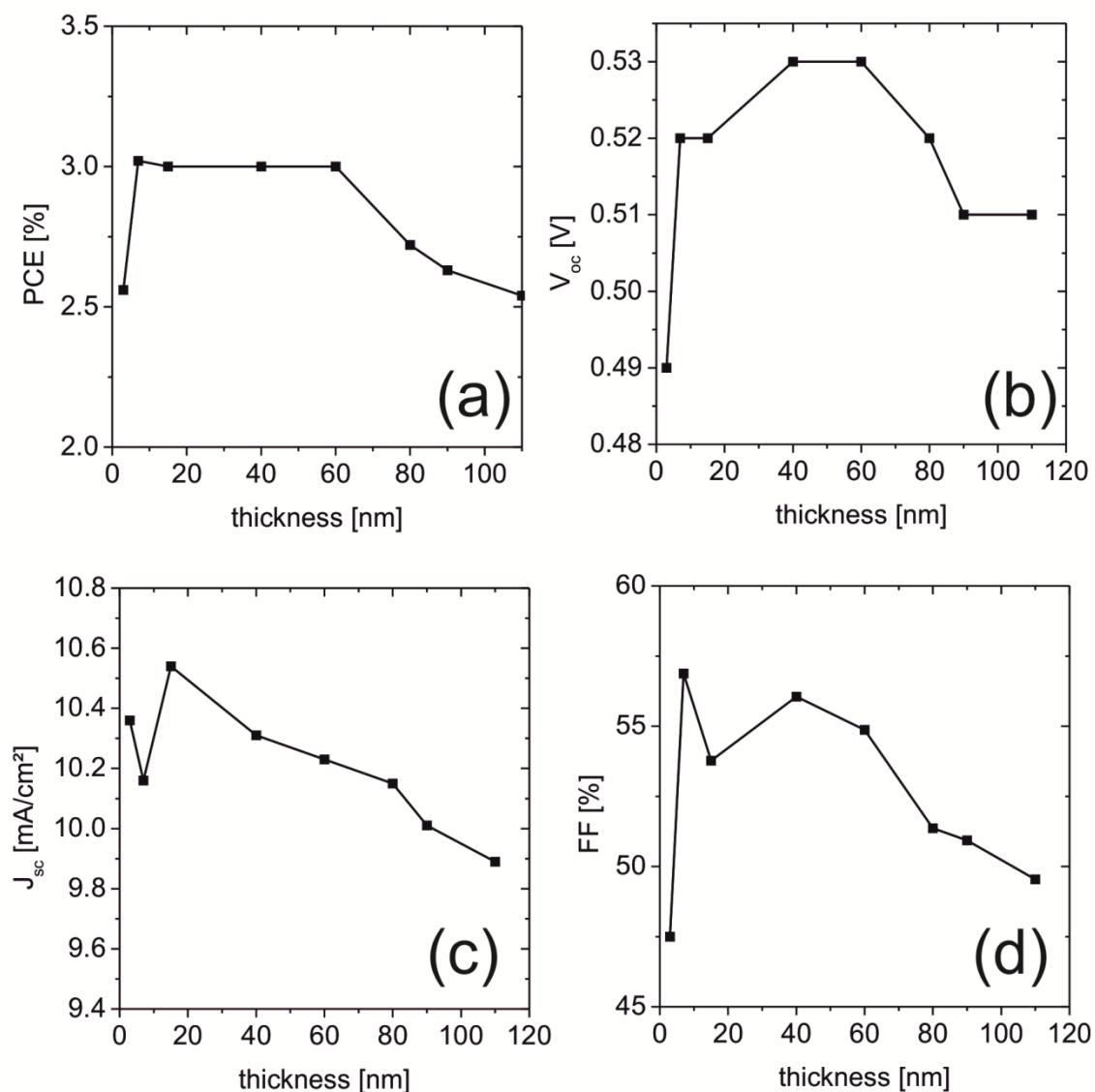
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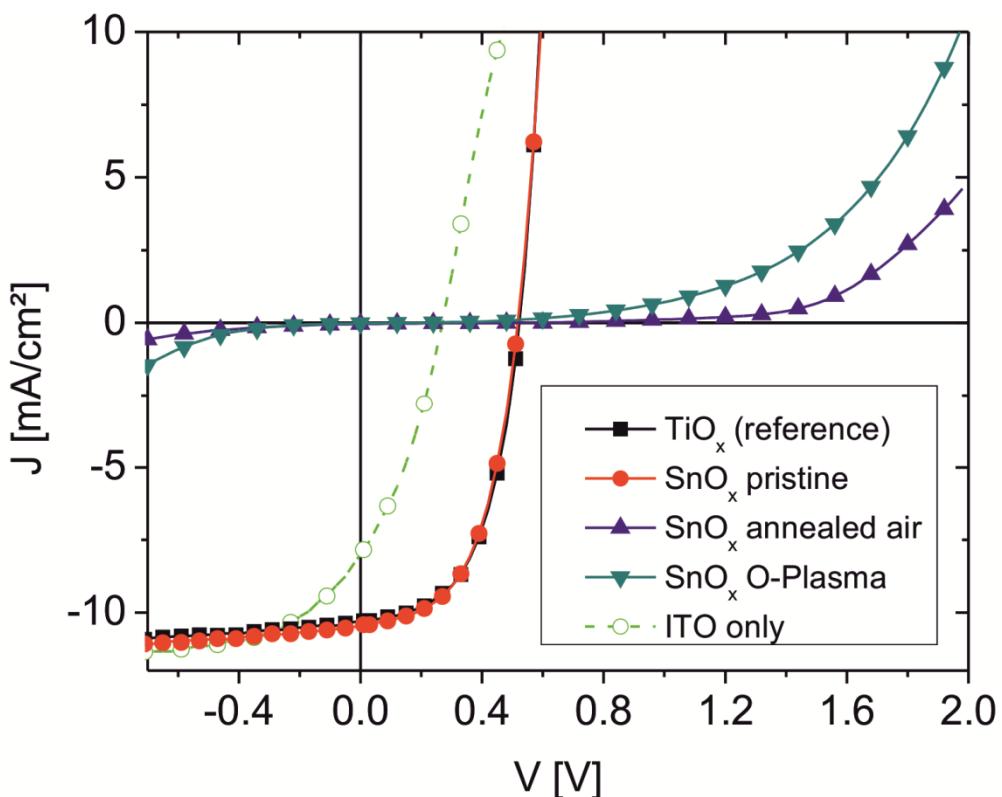
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**Figure S1:** XPS spectrum of the Sn3d peaks of a pristine  $\text{SnO}_x$  layer. The peaks have been fit using a Gauss-Lorentz profile.



**Figure S2.** Characteristics of OSCs with a varied thickness of the pristine  $\text{SnO}_x$  layer. (a) PCE, (b)  $V_{oc}$ , (c)  $J_{sc}$  and (d) FF. Each data point is an average over all cells with the same  $\text{SnO}_x$  thickness on one substrate.



**Figure S3:** *I-V* characteristics of OSCs based on  $\text{SnO}_x$  electron extraction layers under illumination (AM1.5G,  $100 \text{ mW/cm}^2$ ). The  $\text{SnO}_x$  electron extraction layers are either pristine or have been treated by annealing in air or oxygen plasma prior to the deposition of the organic BHJ. The cells based on  $\text{TiO}_x$  or on ITO only are shown as reference.

OSC devices with a  $\text{SnO}_x$  layer that has either been annealed in air or has been treated with an oxygen plasma show strongly S-shaped *I-V* characteristics. It is known that an injection barrier at the electrode does not cause S-shaped *I-V* characteristics in BHJ solar cells but rather leads to a reduction of  $V_{\text{oc}}$ .<sup>[1, 2]</sup> This can be seen for the *I-V* curve of a device without electron extraction interlayer (ITO only) which shows a low  $V_{\text{oc}} = 0.23 \text{ V}$  and a low  $FF$  but no pronounced S-shape. Similarly, a low  $V_{\text{oc}}$  is also found for the device with the plasma treated  $\text{SnO}_x$  layer. Its high WF of  $5.13 \text{ eV}$  makes an injection barrier for electrons a likely explanation. In recent reports, severely S-shaped *I-V* characteristics have been unambiguously associated with a strongly limited extraction of charges.<sup>[1-3]</sup> This hints to a poor electron extraction if annealed or plasma treated  $\text{SnO}_x$  is used. The dramatically decreased conductivity of  $\text{SnO}_x$  layers annealed in air ( $\sim 3-6 \times 10^{-6} \text{ S/cm}$ ) compared to the pristine

layers ( $\sim 1\text{--}2 \times 10^{-5}$  S/cm) also leads to deteriorated device characteristics. Specifically, a high series resistance of  $100 \Omega \text{cm}^2$  is found for the devices with air annealed  $\text{SnO}_x$  compared to  $1.8 \Omega \text{cm}^2$  for that based on the pristine  $\text{SnO}_x$ .

**Table S1.** Characteristics (open circuit voltage ( $V_{oc}$ ), short-circuit current density ( $J_{sc}$ ) and filling factor (FF)) of inverted OSCs with  $\text{TiO}_x$  layer. The cells are either pristine or have been treated in climate cabinet for 60 min. The devices are without encapsulation.

|                                | PCE [%] | $V_{oc}$ [V] | $J_{sc}$ [ $\text{mA cm}^{-2}$ ] | FF [%] | $R_s$ [ $\Omega \text{cm}^2$ ] |
|--------------------------------|---------|--------------|----------------------------------|--------|--------------------------------|
| $\text{TiO}_x$ (pristine cell) | 3.0     | 0.52         | 10.0                             | 57     | 2.7                            |
| $\text{TiO}_x$ (80°C/30%rh)    | 2.6     | 0.53         | 10.0                             | 50     | 5.1                            |
| $\text{TiO}_x$ (80°C/80%rh)    | 1.4     | 0.53         | 8.5                              | 32     | 12.8                           |

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[2] H. Schmidt, T. Winkler, I. Baumann, S. Schmale, H. Flugge, H. H. Johannes, S. Hamwi, T. Rabe, T. Riedl, W. Kowalsky, Appl. Phys. Lett. 2011, 99, 033304.  
[3] H. Schmidt, K. Zilberberg, S. Schmale, H. Flugge, T. Riedl, W. Kowalsky, Appl. Phys. Lett. 2010, 96, 243305.